EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet (Preliminary)

Full Color Side View LEDs (Height 0.8mm)

99-135/RSGHB7C-C06/2D

Features

- White package.
- Optical indicator.
- Colorless clear window.
- Ideal for backlight and light pipe application.
- Inter reflector.
- Wide viewing angle.
- Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- Computable with automatic placement equipment.
- Available on tape and reel (12mm Tape)
- Pb-free
- The product itself will remain within RoHS compliant version.

Descriptions

• The 99-135 series is available in soft red, green and blue. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes the ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD's, switches and symbols.
- Light pipe application.
- General use.

Device Selection Guide

	Lens Color			
Type	Material	Emitted Color	Lens Color	
RS	AlGaInP	Brilliant Red	Water Clear	
GH	InGaN	Brilliant Green		
В7	InGaN	Blue		



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Prepared by: Ray Yuan

Rev. 1

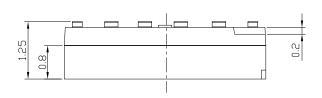
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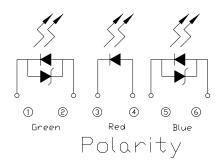
Page: 1 of 12

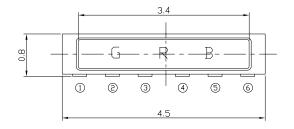
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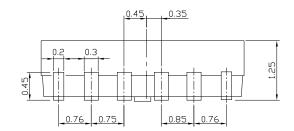
Package Outline Dimensions

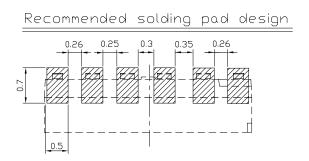












Note: The tolerances unless mentioned is ± 0.1 mm; Unit = mm

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Device No.:

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Page: 2 of 12



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol		Rating	Unit	
Reverse Voltage		V_R	5	V	
	IF	RS	50		
Forward Current		GH	30	mA	
		В7	30	<u> </u>	
		RS	100		
Peak Forward Current(Duty 1/10@ 1KHZ)	I_{FP}	GH	100	mA	
1/10@ 1KHZ)		В7	100	1112 \$	
	Pd	RS	130		
Power Dissipation		GH	110	mW	
		В7	110		
Electroptet's		RS	2000		
Electrostatic	ESD	GH	2000	V	
Discharge(HBM)		В7	2000		
Operating Temperature	Topr		-40 ~ +85	$^{\circ}$ C	
Storage Temperature	Tstg		-40~ +90	$^{\circ}\mathbb{C}$	
Soldering Temperature	Tsol		Reflow Soldering: 260 °C for 10 sec.		
5 · · · · · · · ·			Hand Soldering: 350 °C for 3 sec.		

Rev. 1

Page: 3 of 12

prepared date:07-Feb-2007



Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol		Min.	Тур.	Max.	Unit	Condition	
	Iv	RS	50	80				
Luminous Intensity		GH	200	300		mcd	I _F =5mA	
		В7	20	40				
Viewing Angle	2 θ 1/2			120		deg	I _F =5mA	
	λp	RS		632		nm	I _F =5mA	
Peak Wavelength		GH		518				
		В7		468				
	λd	RS		625		nm	I _F =5mA	
Dominant Wavelength		GH		530				
		В7		460				
	ıΔλ	RS		20		nm	I _F =5mA	
Spectrum Radiation Bandwidth		GH		36				
Build Wilder		В7		26				
	V _F	RS		1.8	2.4	v	I _F =5mA	
Forward Voltage		GH		3.0	3.7			
		В7		3.0	3.7			
Reverse Current	I_R	RS			10	μ A	$V_R=5V$	

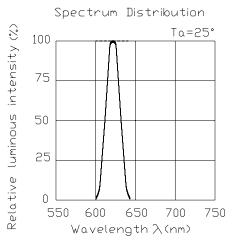
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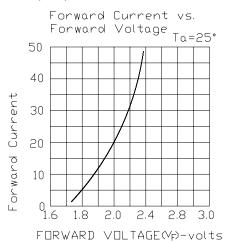
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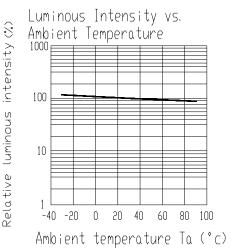
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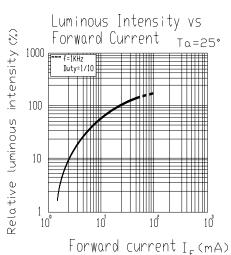
Page: 4 of 12

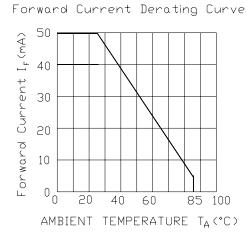
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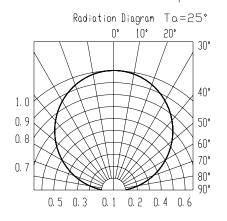




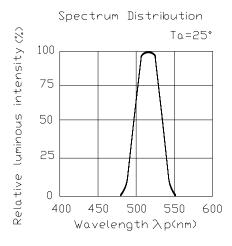


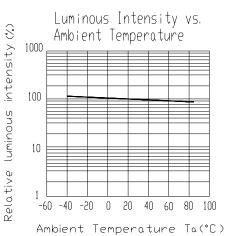


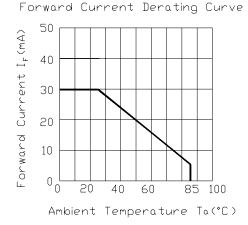


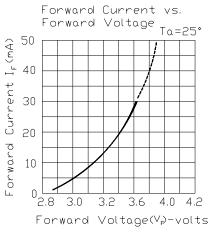


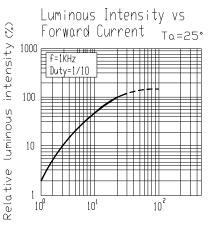
Typical Electro-Optical Characteristics Curves(GH)

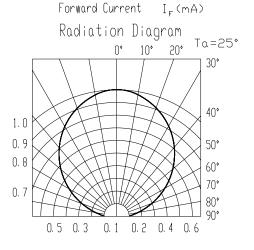




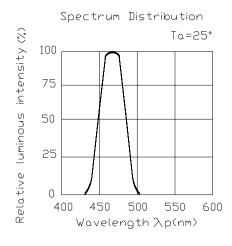


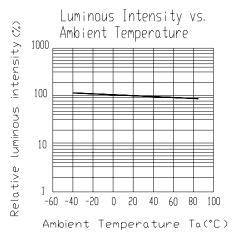


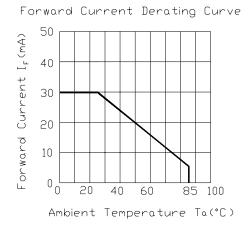


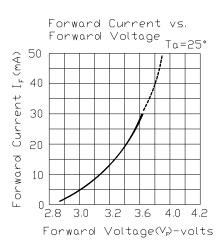


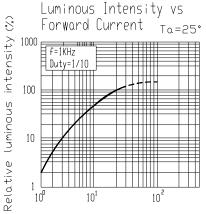
Typical Electro-Optical Characteristics Curves(B7)

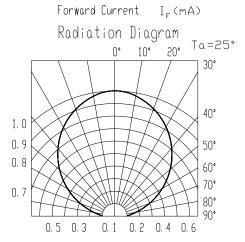












Label explanation

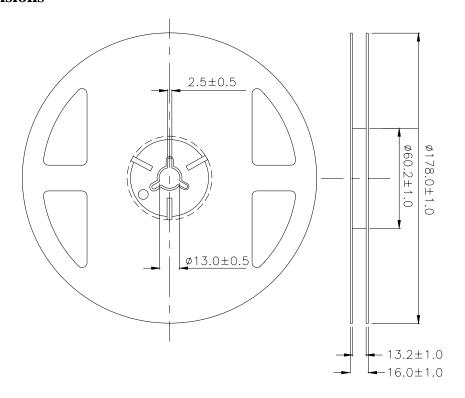
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank

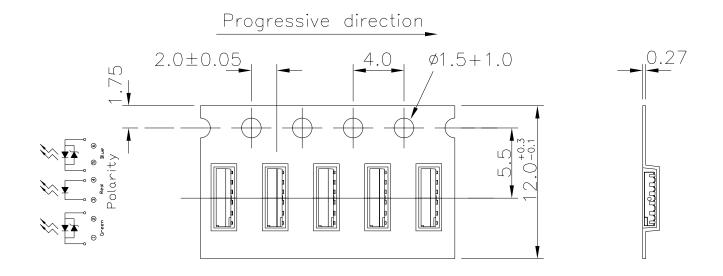


Reel Dimensions



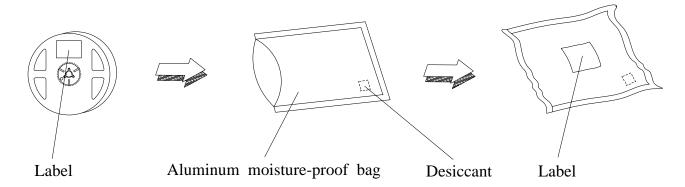
Note: Tolerances Unless Dimension ± 0.1 mm, Unit = mm

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel.



Note: 1.Tolerances Unless Dimension ± 0.1 mm Unit = mm

Moisture Resistant Packaging



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Device No.: prepared date:07-Feb-2007

Rev. 1

Page: 9 of 12

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 10sec.	6 min	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/RH85%	1000 Hrs.	22 PCS.	0/1

Device No.:

prepared date:07-Feb-2007

Rev. 1 Page: 10 of 12

Precautions For Use

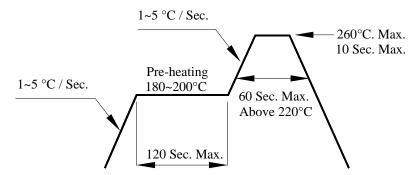
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

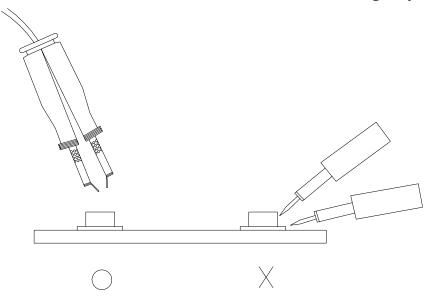
Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

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5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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